- **Center-Pin V$_{CC}$ and GND Configurations Minimize High-Speed Switching Noise**

- **_EPIC_™ (Enhanced-Performance Implanted CMOS) 1-μm Process**

- **500-mA Typical Latch-Up Immunity at 125°C**

- **Package Options Include Plastic Small-Outline (D) and Thin Shrink Small-Outline (PW) Packages, and Standard Plastic 300-mil DIPs (N)**

D, N, OR PW PACKAGE
(TOP VIEW)

1$\overline{\text{PRE}}$	1	14	1CLK
1Q	2	13	1D
1$\overline{\text{Q}}$	3	12	1$\overline{\text{CLR}}$
GND	4	11	V$_{CC}$
2$\overline{\text{Q}}$	5	10	2$\overline{\text{CLR}}$
2Q	6	9	2D
2$\overline{\text{PRE}}$	7	8	2CLK

description

This device contains two independent positive-edge-triggered D-type flip-flops. A low level at the preset ($\overline{\text{PRE}}$) or clear ($\overline{\text{CLR}}$) input sets or resets the outputs regardless of the levels of the other inputs. When $\overline{\text{PRE}}$ and $\overline{\text{CLR}}$ are inactive (high), data at the data (D) input that meets the setup-time requirements are transferred to the outputs on the low-to-high transition of the clock (CLK) pulse. Clock triggering occurs at a voltage level and is not directly related to the rise time of the clock pulse. Following the hold-time interval, data at the D input may be changed without affecting the levels at the outputs.

The 74AC11074 is characterized for operation from –40°C to 85°C.

FUNCTION TABLE

INPUTS				OUTPUT	
$\overline{\text{PRE}}$	$\overline{\text{CLR}}$	CLK	D	Q	$\overline{\text{Q}}$
L	H	X	X	H	L
H	L	X	X	L	H
L	L	X	X	H†	H†
H	H	↑	H	H	L
H	H	↑	L	L	H
H	H	L	X	Q$_0$	$\overline{\text{Q}}_0$

† This configuration is nonstable; that is, it does not persist when $\overline{\text{PRE}}$ or $\overline{\text{CLR}}$ returns to its inactive (high) level.

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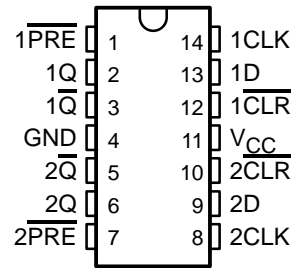**TEXAS INSTRUMENTS**

POST OFFICE BOX 655303 ● DALLAS, TEXAS 75265

74AC11074
DUAL POSITIVE-EDGE-TRIGGERED D-TYPE FLIP-FLOP
WITH CLEAR AND PRESET

SCAS499A – DECEMBER 1986 – REVISED APRIL 1996

logic symbol†
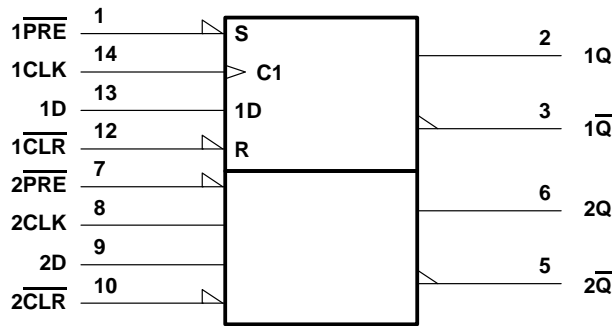
† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V_{CC} .... –0.5 V to 7 V

Input voltage range, V_I (see Note 1) .... –0.5 V to V_{CC} + 0.5 V

Output voltage range, V_O (see Note 1) .... –0.5 V to V_{CC} + 0.5 V

Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) .... ±20 mA

Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) .... ±50 mA

Continuous output current, I_O ($V_O = 0$ to V_{CC}) .... ±50 mA

Continuous current through V_{CC} or GND .... ±100 mA

Maximum power dissipation at $T_A = 55°C$ (in still air) (see Note 2): D package .... 1.25 W

N package .... 1.1 W

PW package .... 0.5 W

Storage temperature range, T_{stg} .... –65°C to 150°C

‡ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and
functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not
implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils,
except for the N package, which has a trace length of zero.

recommended operating conditions

			MIN	NOM	MAX	UNIT
V_{CC}	Supply voltage		3	5	5.5	V
V_{IH}	High-level input voltage	V_{CC} = 3 V	2.1			V
		V_{CC} = 4.5 V	3.15			
		V_{CC} = 5.5 V	3.85			
V_{IL}	Low-level input voltage	V_{CC} = 3 V			0.9	V
		V_{CC} = 4.5 V			1.35	
		V_{CC} = 5.5 V			1.65	
V_I	Input voltage		0		V_{CC}	V
V_O	Output voltage		0		V_{CC}	V
I_{OH}	High-level output current	V_{CC} = 3 V			−4	mA
		V_{CC} = 4.5 V			−24	
		V_{CC} = 5.5 V			−24	
I_{OL}	Low-level output current	V_{CC} = 3 V			12	mA
		V_{CC} = 4.5 V			24	
		V_{CC} = 5.5 V			24	
$\Delta t/\Delta v$	Input transition rise or fall rate		0		10	ns/V
T_A	Operating free-air temperature		−40		85	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		V_{CC}	T_A = 25°C			MIN	MAX	UNIT
				MIN	TYP	MAX			
V_{OH}	I_{OH} = −50 μA		3 V	2.9			2.9		V
			4.5 V	4.4			4.4		
			5.5 V	5.4			5.4		
	I_{OH} = −4 mA		3 V	2.58			2.48		
	I_{OH} = −24 mA		4.5 V	3.94			3.8		
			5.5 V	4.94			4.8		
	I_{OH} = −75 mA†		5.5 V				3.85		
V_{OL}	I_{OL} = 50 μA		3 V			0.1		0.1	V
			4.5 V			0.1		0.1	
			5.5 V			0.1		0.1	
	I_{OL} = 12 mA		3 V			0.36		0.44	
	I_{OL} = 24 mA		4.5 V			0.36		0.44	
			5.5 V			0.36		0.44	
	I_{OL} = 75 mA†		5.5 V					1.65	
I_I	V_I = V_{CC} or GND		5.5 V		±0.1			±1	μA
I_{CC}	V_I = V_{CC} or GND, I_O = 0		5.5 V		4			40	μA
C_i	V_I = V_{CC} or GND		5 V		3.5				pF

† Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

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timing requirements over recommended operating free-air temperature range,
V_{CC} = 3.3 V $\pm$ 0.3 V (see Figure 1)

			T_A = 25°C		MIN	MAX	UNIT
			MIN	MAX			
f_{clock}	Clock frequency		0	100	0	100	MHz
t_w	Pulse duration	$\overline{PRE}$ or $\overline{CLR}$ low	4		4		ns
		CLK low or high	5		5		
t_{su}	Setup time before CLK↑	Data high or low	5		5		ns
		$\overline{PRE}$ or $\overline{CLR}$ inactive	1		1		
t_h	Hold time after CLK↑		0		0		ns

timing requirements over recommended operating free-air temperature range,
V_{CC} = 5 V $\pm$ 0.5 V (see Figure 1)

			T_A = 25°C		MIN	MAX	UNIT
			MIN	MAX			
f_{clock}	Clock frequency		0	125	0	125	MHz
t_w	Pulse duration	$\overline{PRE}$ or $\overline{CLR}$ low	4		4		ns
		CLK low or CLK high	4		4		
t_{su}	Setup time before CLK↑	Data high or low	3.5		3.5		ns
		$\overline{PRE}$ or $\overline{CLR}$ inactive	1		1		
t_h	Hold time after CLK↑		0		0		ns

switching characteristics over recommended operating free-air temperature range,
V_{CC} = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	T_A = 25°C			MIN	MAX	UNIT
			MIN	TYP	MAX			
f_{max}			100	125		100		MHz
t_{PLH}	$\overline{PRE}$ or $\overline{CLR}$	Q or $\overline{Q}$	1.5	5.8	9.3	1.5	10	ns
t_{PHL}			1.5	6.5	11.4	1.5	12.2	
t_{PLH}	CLK	Q or $\overline{Q}$	1.5	7.7	10.5	1.5	11.3	ns
t_{PHL}			1.5	7.3	9.7	1.5	10.6	

switching characteristics over recommended operating free-air temperature range,
V_{CC} = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	T_A = 25°C			MIN	MAX	UNIT
			MIN	TYP	MAX			
f_{max}			125	150		125		MHz
t_{PLH}	$\overline{PRE}$ or $\overline{CLR}$	Q or $\overline{Q}$	1.5	4.2	6.6	1.5	7.1	ns
t_{PHL}			1.5	4.7	8.2	1.5	9	
t_{PLH}	CLK	Q or $\overline{Q}$	1.5	5.4	7.5	1.5	8.2	ns
t_{PHL}			1.5	5	6.9	1.5	7.5	

operating characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS	TYP	UNIT
C_{pd}	Power dissipation capacitance	C_L = 50 pF, f = 1 MHz	30	pF

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PARAMETER MEASUREMENT INFORMATION

From Output Under Test

C_L = 50 pF (see Note A)

500 Ω

LOAD CIRCUIT

t_w

Input 50% 50% V_{CC} 0 V

VOLTAGE WAVEFORMS

Timing Input (see Note B) 50% V_{CC} V_{CC} 0 V

t_{su} t_h

Data Input 50% V_{CC} 50% V_{CC} V_{CC} 0 V

VOLTAGE WAVEFORMS

Input (see Note B) 50% V_{CC} 50% V_{CC} V_{CC} 0 V

t_{PLH} t_{PHL}

In-Phase Output 50% V_{CC} 50% V_{CC} V_{OH} V_{OL}

t_{PHL} t_{PLH}

Out-of-Phase Output 50% V_{CC} 50% V_{CC} V_{OH} V_{OL}

VOLTAGE WAVEFORMS
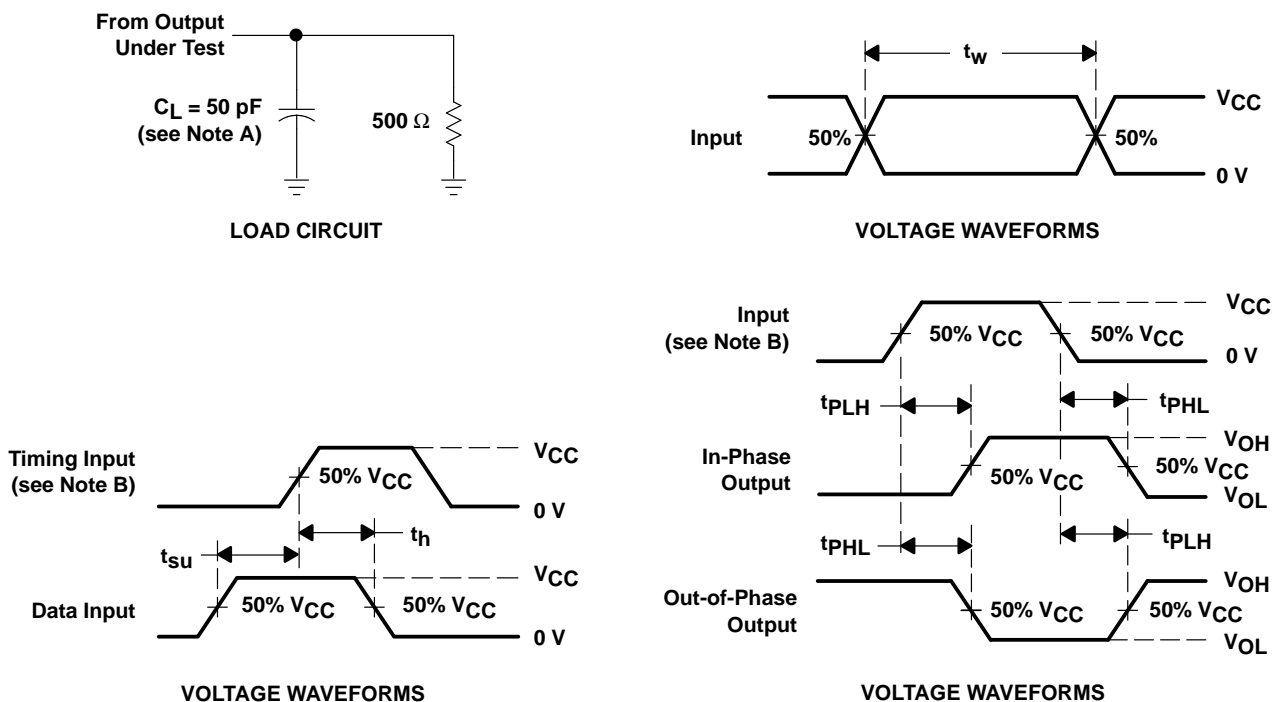
NOTES: A. C_L includes probe and jig capacitance.
B. All input pulses are supplied by generators having the following characteristics: PRR $\leq$ 10 MHz, Z_O = 50 Ω, t_r = 3 ns, t_f = 3 ns.
C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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